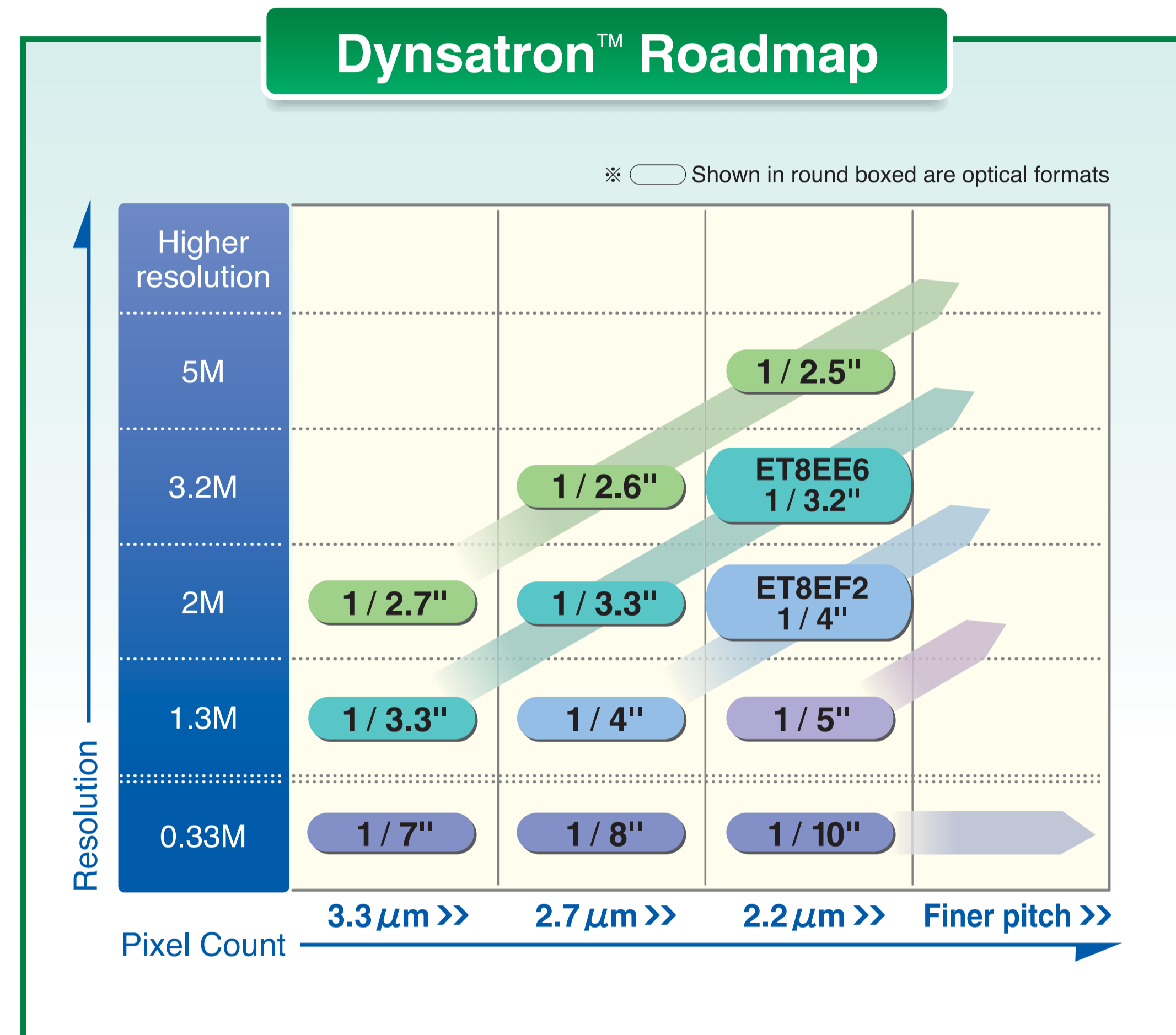


Small Package, Low Power Consumption and High Resolution CMOS Area Image Sensor Dynastron™

小封装, 低功耗, 高清晰度 CMOS面阵图像传感器 Dynastron™

- Dynastron technology provides world-class image quality.
- Reduce the pixel pitch from 2.7 μm to 2.2 μm, realizing approx. 3.2 megapixels in a 1/3.2-inch, approx. 2.0 megapixels in a 1/4-inch optical format.
- Supports a frame rate of 15 fps at the maximum image resolution

- Dynastron技术提供世界级水准的图像质量
- 像素间距从2.7 μm减小到2.2 μm, 实现1/3.2英寸对应320万像素的光学格式, 1/4英寸对应200万像素的光学格式.
- 在最大图像清晰度下支持15fps帧率



TOSHIBA HDN

东芝HDN

HDN : High Definition Network

Device technology that powerfully supports HDN.

东芝的元器件技术全力支持HDN。

Role of CMOS Area Image Sensor "Dynastron™"

CMOS面阵图像传感器(Dynastron™)的功能

HDN elemental technology for increased pixels through remarkable CMOS technology
这项HDN基本技术用于通过卓越的CMOS技术而增加的像素。

TOSHIBA
Leading Innovation >>>

领先·创新